



Docket No.: H0498.70130US01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Tao Deng  
Serial No.: 10/763,819  
Confirmation No.: 5026  
Filed: January 23, 2004  
For: FABRICATION OF METALLIC MICROSTRUCTURES VIA  
EXPOSURE OF PHOTSENSITIVE COMPOSITION  
Examiner: K. Duda  
Art Unit: 1756

Certificate of Mailing Under 37 CFR 1.8(a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: 4/11/07

Melanie Chew Sand  
Signature

TRANSMITTAL LETTER

Mail Stop Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

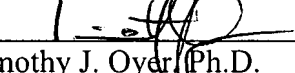
Enclosed are the following items for filing in connection with the above-referenced  
Patent Application:

1. Amendment After Allowance;
2. Part B - Issue Fee Transmittal; and
3. Return Receipt Postcard.

Our check in the amount of \$1,000.00 covering the required fees. is enclosed. The Director is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 23/2825, under Docket No. H0498.70130US01. A duplicate copy of this paper is enclosed.

Dated: April 11, 2007

Respectfully submitted,

By   
Timothy J. Oyer (Ph.D.)  
Registration No.: 36,628  
WOLF, GREENFIELD & SACKS, P.C.  
Federal Reserve Plaza  
600 Atlantic Avenue  
Boston, Massachusetts 02210-2206  
(617) 646-8000